

# APPROVAL SHEET

# **MR18X, MR20X, MR25X**

±1%, ±5%

Power chip resistors
Size 1218, 2010, 2512
Automotive & Military Compliant
Anti-sulfur ASTM B-809 60°C 500hs
RoHS 2 Compliant with exemption 7C-I
Halogen free

\*Contents in this sheet are subject to change without prior notice.



#### **FEATURE**

- High power rating and compact size
- 2. High reliability and stability
- 3. Automotive AEC Q-200 compliant
- 4. 100% CCD visual inspection
- 5. RoHS 2 compliant with exemption 7C-I and Halogen free products
- 6. Anti-sulfuration ASTM B-809 60°C 500hs

#### **APPLICATION**

- · Power supply
- Industry
- Motor control
- M/B Computer
- Automotives
- Servo

#### **DESCRIPTION**

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to nominated value within tolerance which controlled by laser trimming of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (lead free) alloy.

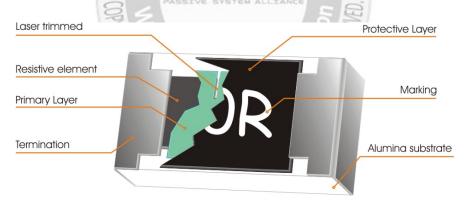


Fig 1. Construction of 2512, 2010 Chip-R

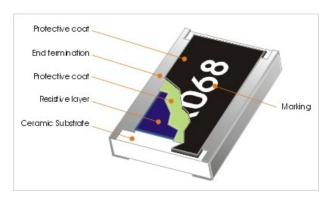


Fig 2. Construction of 1218 Chip-R

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#### **QUICK REFERENCE DATA**

Item	General Specification			
Series No.	MR18	MR20	MR25	
Size code	1218(3248)	2010 ( 5025 ),	2512(6432)	
Resistance Tolerance	±!	5% (E24); ±1% (E24+E9	6)	
Resistance Range	,	$1\Omega$ ~ 10M $\Omega$ , Jumper (0 $\Omega$	)	
TCR (ppm/°C) < 10Ω	± 200 ppm/°C	± 200 ppm/°C	± 200 ppm/°C	
10Ω ~ 1ΜΩ	± 100 ppm/°C	± 100 ppm/°C	± 100 ppm/°C	
> 1MΩ	± 200 ppm/°C	± 200 ppm/°C	± 200 ppm/°C	
Max. dissipation at T <sub>amb</sub> =70°C	1W	0.75 W	1W	
Max. Operation Voltage (DC or RMS)	200V	200V	250V	
Max. Overload Voltage (DC or RMS)	400V 400V 500V			
Climatic category (IEC 60068)	55/155/56			

#### Test conditions for jumper ( 0 ohm )

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Туре	MR18X	MR20X	MR25X
Power Rating At 70C	1 W	3/4 W	1.W
Resistance	Max. 50mR	Max. 50mR	Max. 50mR
Rated Current	4.5 A	3.2 A	4.5 A
Peak Current	11 A	PASSIV8 AVSTEM AT	LTANCE 11 A
Operating Temperature	高い	-55℃ ~ 155℃	多度

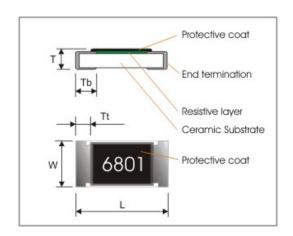
#### Note:

- 1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
- 2. Max. Operation Voltage: So called RCWV (Rated Continuous Working Voltage) is determined by

 $RCWV = \sqrt{Rated Power \times Resistance \ Value}$  or Max. RCWV listed above, whichever is lower.

# **MECHANICAL DATA (unit: mm)**

TYPE	MR18	MR20	MR25	
L	3.05±0.15 5.00±0.20		6.40±0.20	
W	4.60±0.20	2.50±0.20	3.20±0.20	
Т	T 0.55±0.10		0.60±0.10	
Tt	0.45±0.25	0.65±0.25	0.65±0.25	
Tb	0.50±0.25	0.60±0.25	0.90±0.25	



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#### **MARKING**

Each resistor is marked with a four-digit code on the protective coating to designate the nominal resistance value  $\pm 5\%, \pm 1\%$  tolerance!

Size	±5%	±1%	
2512, 2010, 1218	4-digits marking	4-digits marking	

#### **FUNCTIONAL DESCRIPTION**

#### **Product characterization**

Standard values of nominal resistance are taken from the E96 & E24 series for resistors with a tolerance of  $\pm 5\%$  &  $\pm 1\%$ . The values of the E24/E96 series are in accordance with "IEC publication 60063".

# **Derating curve**

The power that the resistor can dissipate depends on the operating temperature; see Fig.3

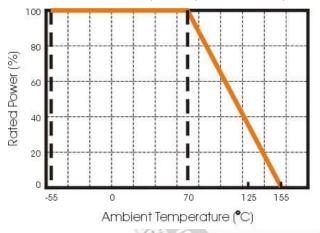


Fig 3 Maximum dissipation in percentage of rated power as a function of the ambient temperature

#### MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems. Chip placement can be on ceramic substrates and printed-circuit boards (PCBs). Electrical connection to the circuit is by individual soldering condition. The end terminations guarantee a reliable contact.

#### **SOLDERING CONDITION**

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 4.

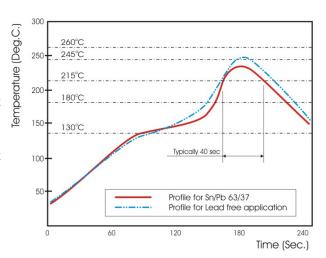


Fig 4. Infrared soldering profile for Chip Resistors

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#### **CATALOGUE NUMBERS**

The resistors have a catalogue number starting with .

MR25	х	472_	J	Т	L
Size code	Type code	Resistance code	Tolerance	Packaging code	Termination
MR25 : 2512 MR20 : 2010 MR18 : 1218	X: $\pm 5\%$ : 1Ω-10MΩ $\pm 1\%$ : 10Ω-1MΩ W: $\pm 1\%$ : < 10Ω; >1MΩ	$\pm 5\%$ : E24: 2 significant digits followed by no. of zeros and a blank $100\Omega = 101\_10K\Omega = 103\_$ ("_" means a blank ) $\pm 1\%$ : E24+E96: 3 significant	F:±1% J:±5% P:Jumper	T: 7" Reeled taping Q: 10" Reeled taping G: 13" Reeled taping B: Bulk	code L = Sn base (lead free)
		digits followed by no. of zeros $102\Omega = 1020$ $37.4K\Omega = 3742$			

<sup>\* 100%</sup> CCD visual inspection to guarantee visual quality!

#### **TEST AND REQUIREMENTS**

Essentially all tests are carried out according to the schedule of IEC publication 115-8, category LCT/UCT/56(rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days). The testing also meets the requirements specified by EIA, EIAJ and JIS.

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, subclause 5.3. Unless otherwise specified, the following value supplied:

Temperature: 15°C to 35°C. Relative humidity: 45% to 75%.

Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar). All soldering tests are performed with midly activated flux.

TEST PROCEDURE / TEST METHOD		REQUIREMENT	EQUIREMENT	
1231	PROCEDURE / TEST WIETHOD	Resistor	0Ω	
Electrical	- DC resistance values measurement	Within the specified tolerance		
Characteristics	- Temperature Coefficient of Resistance (T.C.R)	Refer to "QUICK REFERENCE	DATA"	
JISC5201-1: 1998	Natural resistance change per change in degree centigrade.			
Clause 4.8	$\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)}  t_1 : 20^{\circ}\text{C} + 5^{\circ}\text{C} - 1^{\circ}\text{C}$			
	R <sub>1</sub> : Resistance at reference temperature			
	R <sub>2</sub> : Resistance at test temperature			
Resistance to soldering	Un-mounted chips completely immersed for	$\Delta$ R/R max. $\pm$ (0.5%+0.05 $\Omega$ )		
heat (R.S.H)	eat (R.S.H) 10±1second in a SAC solder bath at 270℃±5°C			
MIL-STD-202 method 210				

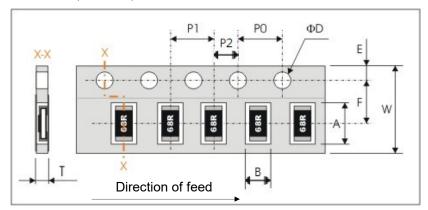
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TEAT	PROCEDURE (TEXT METURE	REQUIREMENT		
TEST	PROCEDURE / TEST METHOD	Resistor	0Ω	
Solderability J-STD-002	<ul> <li>a) Bake the sample for 155°C dwell time 4hrs/ solder dipping 235°C/ 5sec.</li> <li>b) Steam the sample dwell time 1 hour/ solder dipping 260°C/ 7sec.</li> </ul>	95% coverage min., good tinning visible damage	g and no	
Temperature cycling JESD22 Method JA-104	1000 cycles, -55°C ~ +155°C, dwell time 5~10min	$\Delta$ R/R max. $\pm$ (0.5%+0.05 $\Omega$ ) No visible damage	<50mΩ	
Moisture Resistance MIL-STD-202 method 106	loisture Resistance $65\pm2^{\circ}$ C, $80\sim100\%$ RH, $10$ cycles, 24 hours/ cycle $\Delta$ R/R max. $\pm(0.5\%\pm0.05\Omega)$ No visible damage		<50mΩ	
Bias Humidity MIL-STD-202 method 103	1000+48/-0 hours; 85°C, 85% RH, 10% of operation power	$\Delta$ R/R max. $\pm$ (1.0%+0.05 $\Omega$ ) No visible damage	<50mΩ	
Operational Life MIL-STD-202 method 108	1000+48/-0 hours; 35% of operation power, 125±2°C	$\Delta$ R/R max. $\pm$ (1%+0.05 $\Omega$ ) No visible damage	<50mΩ	
High Temperature Exposure MIL-STD-202 Method 108	chamber controlled 155±3°C No visible damag		<50mΩ	
Mechanical Shock MIL-STD-202 method 213	1/2 Sine Pulse / 1500g Peak / Velocity 15.4ft/sec	Within the specified tolerance No visible damage	<50mΩ	
Board Flex AEC-Q200-005	Resistors mounted on a 90mm glass epoxy resin PCB(FR4), bending once 2mm for 10sec	$\Delta$ R/R max. $\pm$ (1.0%+0.05 $\Omega$ ). No visible damage	<50mΩ	
Terminal strength AEC-Q200-006	Pressurizing force: 1.8Kg, Test time: 60±1sec.	No remarkable damage or rer the terminations	moval of	
Vibration MIL-STD-202 method 204	Test 5g's for 20min., 12 cycles each of 3 orientations	$\Delta$ R/R max. $\pm$ (1.0%+0.05 $\Omega$ ) No visible damage	<50mΩ	
Thermal shock MIL-STD-202 method 107	No visible damage		<50mΩ	
ESD AEC-Q200-002	Test contact 3.0KV	$\Delta$ R/R max. $\pm$ (1.0%+0.05 $\Omega$ ). No visible damage	<50mΩ	
Sulfuration test ASTM B-809-95	ASTM B-809 60°C 500hrs	$\pm$ 5%: ΔR/R max. $\pm$ (2%+0.10 $\Omega$ ) $\pm$ 1%: ΔR/R max. $\pm$ (2%+0.05 $\Omega$ ) No visible damage	<50mΩ	

## **PACKAGING**

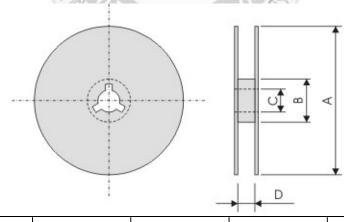
## Plastic Tape specifications (unit :mm)



Туре	А	В	W	F	E
MR18	4.90±0.20	3.55±0.30			
MR20	5.50±0.20	2.80±0.20	12.00±0.30	5.50±0.10	1.75±0.10
MR25	6.90±0.20	3.60±0.20			

Туре	P1	P0	P2	ΦD	Т
MR18	8.00±0.10				1.30±0.20
MR20	4.00±0.10	4.00±0.10	2.00±0.10	Ф1.50 <sup>+0.1</sup>	MAX1.2
MR25	4.00±0.10				IVIAA 1.2

#### **Reel dimensions**



Symbol	Α	В	С	D
(unit : mm)	Φ178.0±2.0	Φ60.0±1.0	13.0±0.2	14.0±0.2

# **Taping quantity**

MR20, MR25 by plastic tape taping 4,000 pcs per reel.

MR18 by plastic tape taping 3,000 pcs per reel